



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Re the Application of:

Stearns et al.

Serial No.: 09/678,318

Filed: 10/03/00

For: OPTIMIZED CIRCUIT DESIGN LAYOUT FOR HIGH  
PERFORMANCE BALL GRID ARRAY PACKAGES

Docket: TI-25833.1

Art Unit: 2815

Examiner: TBD

Assistant Commissioner for Patents  
Washington, D. C. 20231

CHANGE OF CORRESPONDENCE ADDRESS

<p>MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(a)</p> <p>I hereby certify that the above correspondence is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on</p> <p><u>5-7-01</u></p> <p><i>Jackie McBride</i></p> <p>Jackie McBride</p>
---

Sir:

Please change the Correspondence Address for the above-identified patent application to:

023494

Texas Instruments Incorporated

P. O. Box 655474 MS 3999

Dallas, TX 75265

Please charge any necessary fees or credit any overpayments to the deposit account of Texas Instruments Incorporated, account number 20-0668.

Respectfully submitted,

Wade James Brady III  
Reg. No. 32,080

Texas Instruments Incorporated  
P. O. Box 655474, MS 3999  
Dallas, Texas 75265  
(972) 917-4371

RECEIVED  
MAY 17 2001  
TC 2800 MAIL ROOM

2815  
#1  
RECEIVED  
MAY 16 2001  
Technology Center 2800  
Flowers